



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	IPB65R150CFDA	<b>Issued</b>	05. May 2021
<b>MA#</b>	MA001218498		
<b>Package</b>	PG-TO263-3-2	<b>Weight*</b>	1564.17 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	11.566	0.74	0.74	7394	7394
leadframe	inorganic material	phosphorus	7723-14-0	0.091	0.01		58	
	non noble metal	iron	7439-89-6	0.304	0.02		195	
	non noble metal	copper	7440-50-8	304.026	19.44	19.47	194368	194621
wire	non noble metal	aluminium	7429-90-5	3.411	0.22	0.22	2181	2181
encapsulation	inorganic material	zinc oxide	1314-13-2	6.791	0.43		4341	
	miscellaneous	miscellaneous	-	27.163	1.74		17366	
	plastics	epoxy resin	-	101.862	6.51		65122	
	inorganic material	silicon dioxide	60676-86-0	543.263	34.73	43.41	347316	434145
lead finish	non noble metal	tin	7440-31-5	9.657	0.62	0.62	6174	6174
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.228	0.01	0.01	146	147
solder	non noble metal	tin	7440-31-5	0.149	0.01		95	
	noble metal	silver	7440-22-4	0.186	0.01		119	
	non noble metal	lead	7439-92-1	7.098	0.45	0.47	4538	4752
heatspreader	inorganic material	phosphorus	7723-14-0	0.165	0.01		105	
	non noble metal	iron	7439-89-6	0.548	0.04		351	
	non noble metal	copper	7440-50-8	547.666	35.01	35.06	350130	350586
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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